

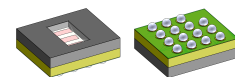
FEATURES

Compact photosensor for high-resolution nonius scanning
 Phased-array design for 511/512/496 PPR (N/M/S channel)
 with excellent signal matching
 Reduced cross talk due to moderate track pitch
 Ultra low dark currents for operation to high temperature
 Low noise amplifiers with high transimpedance of typ. 1 M Ω
 Short-circuit-proof, low impedance voltage outputs for
 enhanced EMI tolerance
 Space saving optoQFN and optoBGA packages
 (RoHS compliant)
 Low power consumption from single 4.5 to 5.5 V supply
 Operational temperature range of -40 to +110 °C
 Suitable code disc:
 LSHC9S 33-512N (glass 1 mm)
 OD \varnothing 33 mm, ID \varnothing 18.0 mm, optical radius 14.5 mm

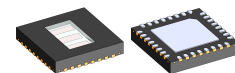
APPLICATIONS

Absolute position encoders

PACKAGES

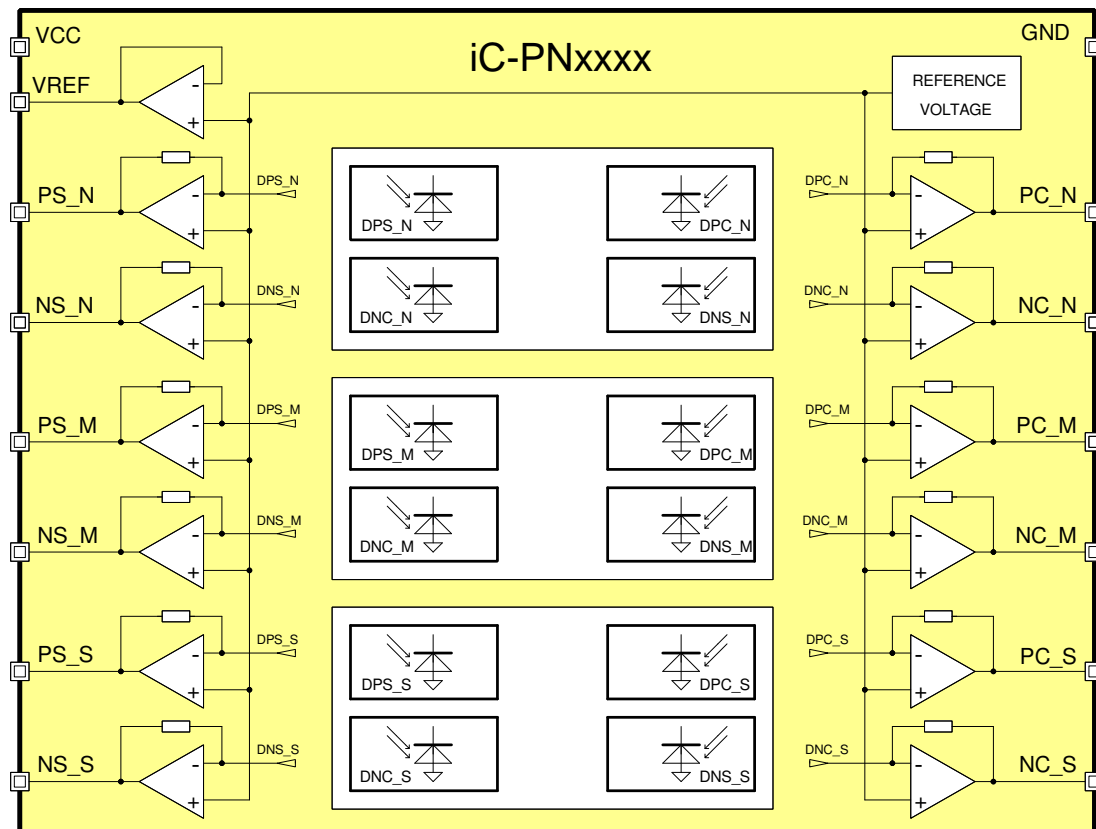


15-pin optoBGA
6.2 mm x 5.2 mm x 1.7 mm



32-pin optoQFN
5 mm x 5 mm x 0.9 mm

BLOCK DIAGRAM



iC-PN3312

PHASED ARRAY NONIUS ENCODER 33-512

preliminary



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DESCRIPTION

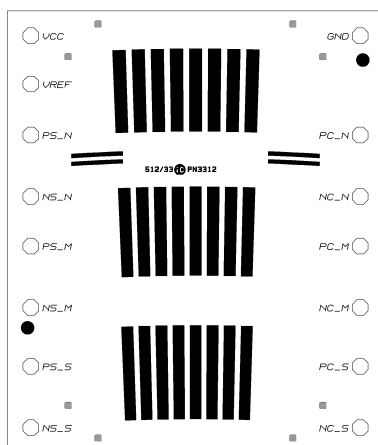
The optical encoder iC-PN features monolithically integrated photosensors arranged as a phased-array.

The transimpedance gain of typically $1\text{ M}\Omega$ generates output signals of a few hundred millivolts already from an illumination level of 0.5 mW/cm^2 . In most cases no additional measures must be considered to filter for noise and interferences. The spectral sensitivity range includes visible to near infrared light, with the maximum sensitivity being close to a wavelength of 680 nm .

Analog nonius-scale encoders are the typical application for iC-PN. Its 3-track scanning features a phased-array of multiple photosensors each per track, generating positive and negative going sine signals, as well as positive and negative going cosine signals. An excellent matching and common mode behavior of the differential signal paths is obtained by a paired amplifier design, reducing the needs for external signal calibration to an absolute minimum.

PACKAGES INFORMATION

PAD LAYOUT (2.88 mm x 3.37 mm)



PAD FUNCTIONS

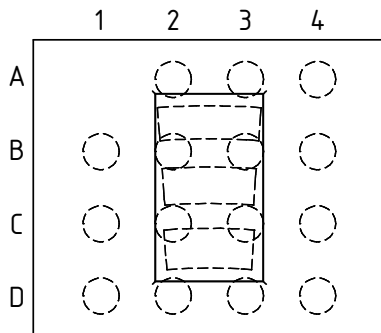
No. Name Function

- | | | |
|----|------|----------------------------|
| 1 | VCC | +4.5..5.5 V Supply Voltage |
| 2 | VREF | Reference Voltage Output |
| 3 | PS_N | N-Track Sine + |
| 4 | NS_N | N-Track Sine - |
| 5 | PS_M | M-Track Sine + |
| 6 | NS_M | M-Track Sine - |
| 7 | PS_S | S-Track Sine + |
| 8 | NS_S | S-Track Sine - |
| 9 | NC_S | S-Track Cosine - |
| 10 | PC_S | S-Track Cosine + |
| 11 | NC_M | M-Track Cosine - |
| 12 | PC_M | M-Track Cosine + |
| 13 | NC_N | N-Track Cosine - |
| 14 | PC_N | N-Track Cosine + |
| 15 | GND | Ground |

All outputs are analog voltage outputs.

PIN CONFIGURATION

oBGA LSH2C (6.2 mm x 5.2 mm)



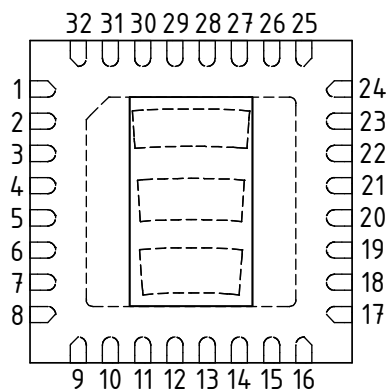
PIN FUNCTIONS

No. Name Function

A2	VCC	+4.5..5.5 V Supply Voltage
A3	VREF	Reference Voltage Output
A4	GND	Ground
B1	PS_N	N-Track Sine +
B2	NS_N	N-Track Sine -
B3	NC_N	N-Track Cosine -
B4	PC_N	N-Track Cosine +
C1	PS_M	M-Track Sine +
C2	NS_M	M-Track Sine -
C3	NC_M	M-Track Cosine -
C4	PC_M	M-Track Cosine +
D1	PS_S	S-Track Sine +
D2	NS_S	S-Track Sine -
D3	NC_S	S-Track Cosine -
D4	PC_S	S-Track Cosine +

PIN CONFIGURATION

oQFN32-5x5 (5 mm x 5 mm)



PIN FUNCTIONS

No. Name Function

1	VCC	+4.5..5.5 V Supply Voltage
2	VREF	Reference Voltage Output
3	PS_N	N-Track Sine +
4	NS_N	N-Track Sine -
5	PS_M	M-Track Sine +
6	NS_M	M-Track Sine -
7	PS_S	S-Track Sine +
8	NS_S	S-Track Sine -
17	NC_S	S-Track Cosine -
18	PC_S	S-Track Cosine +
19	NC_M	M-Track Cosine -
20	PC_M	M-Track Cosine +
21	NC_N	N-Track Cosine -
22	PC_N	N-Track Cosine +
24	GND	Ground

BP Backside pad (oQFN32-5x5 only):
not intended as an electrical connection
point; when using as shield a single link
to GND is permissible.

Package qualification optoQFN32-5x5 pending.

ABSOLUTE MAXIMUM RATINGS

These ratings do not imply operating conditions; functional operation is not guaranteed. Beyond these ratings device damage may occur.

Item No.	Symbol	Parameter	Conditions			Unit
				Min.	Max.	
G001	VCC	Voltage at VCC		-0.3	6	V
G002	I(VCC)	Current in VCC		-20	20	mA
G003	V()	Pin Voltage, all signal outputs		-0.3	VCC + 0.3	V
G004	I()	Pin Current, all signal outputs		-20	20	mA
G005	Vd()	ESD Susceptibility, all pins	HBM, 100 pF discharged through 1.5 kΩ		2	kV
G006	Tj	Junction Temperature		-40	150	°C
G007	Ts	Chip Storage Temperature		-40	150	°C

THERMAL DATA

Item No.	Symbol	Parameter	Conditions				Unit
				Min.	Typ.	Max.	
T01	Ta	Operating Ambient Temperature Range	package oBGA LSH2C	-40		110	°C
			package oQFN32-5x5* (extended temperature range on request)	-40		110	°C
T02	Ts	Storage Temperature Range	package oBGA LSH2C, package oQFN32-5x5*	-40		110	°C
T03	Tpk	Soldering Peak Temperature	package oBGA LSH2C				
			tpk < 20 s, convection reflow tpk < 20 s, vapor phase soldering TOL (time on label) 8 h; Please refer to customer information file No. 7 for details.			245 230	°C °C
T04	Tpk	Soldering Peak Temperature	package oQFN32-5x5*				
			tpk < 20 s, convection reflow tpk < 20 s, vapor phase soldering MSL 5A (max. floor live 24 h at 30 °C and 60 % RH); Please refer to customer information file No. 7 for details.			245 230	°C °C

*) Package qualification pending.

ELECTRICAL CHARACTERISTICS

Operating conditions: VCC = 4.5...5.5 V, Tj = -40...125 °C, unless otherwise stated

Item No.	Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Total Device							
001	VCC	Permissible Supply Voltage		4.5		5.5	V
002	I(VCC)	Supply Current in VCC	no load, photocurrents within linear op. range (no override)		9.5	15	mA
003	Vc()hi	Clamp-Voltage hi at all pins	I() = 4 mA			11	V
004	Vc()lo	Clamp-Voltage lo at all pins	I() = -4 mA	-1.2		-0.3	V
Photosensors							
101	λ_{ar}	Spectral Application Range	$Se(\lambda_{ar}) = 0.25 \times S(\lambda)_{max}$	400		950	nm
102	λ_{pk}	Peak Sensitivity Wavelength			680		nm
103	Aph()	Radiant Sensitive Area			0.077		mm ²
104	S(λ)	Spectral Sensitivity	$\lambda_{LED} = 740$ nm		0.5		A/W
105	S(λ_{pk})max	Maximum Spectral Sensitivity	$\lambda_{LED} = \lambda_{pk}$		0.55		A/W
106	E()mxr	Irradiance For Maximum Signal Level	$\lambda_{LED} = 740$ nm, Vout() not saturated	2.8	5.2	8.4	mW/cm ²
Photocurrent Amplifiers							
201	Iph()	Permissible Photocurrent Operating Range		0		280	nA
202	$\eta()$ r	Photo Sensitivity (light-to-voltage conversion ratio)	$\lambda_{LED} = 740$ nm	0.2	0.3	0.5	V/ μ W
203	Z()	Equivalent Transimpedance Gain	$Z = Vout() / Iph()$	0.7	1.0	1.4	M Ω
204	TCz	Temperature Coefficient of Transimpedance Gain			-0.12		%/°C
209	$\Delta Z()$ pn	Transimpedance Gain Matching	P. channel vs. corresponding N.. channel	-0.2		0.2	%
210	$\Delta Vout()$ pn	Signal Matching	no illumination, any output vs. any output	-35		35	mV
211	$\Delta Vout()$ pn	Signal Matching	no illumination, P. output vs. corresponding N.. output	-2.5		2.5	mV
212	fc()hi	Cut-off Frequency (-3 dB)			400		kHz
213	VNoise()	RMS Output Noise	illuminated to 500 mV signal level above dark level, 500 kHz band width		0.5		mV
Signal Outputs							
301	Vout()mx	Permissible Maximum Output Voltage	illumination to E()mxr, linear gain	2.45	2.72	3.02	V
302	Vout()d	Dark Signal Level	no illumination, load 20 k Ω vs. +2 V	600	770	1000	mV
303	Vout()acmx	Maximum Signal Level	$Vout()acmx = Vout()mx - Vout()d$	1.48	1.96	2.35	V
304	Isc()hi	Short-Circuit Current hi	load current to ground	100	420	800	μ A
305	Isc()lo	Short-Circuit Current lo	load current to IC	250	480	700	μ A
306	Ri()	Internal Output Resistance	f = 1 kHz	70	110	180	Ω
307	ton()	Power-On Settling Time	VCC = 0 V \rightarrow 5 V			100	μ s
Reference Voltage VREF							
401	VREF	Reference Voltage	I(VREF) = 0...+1.6 mA	600	770	1000	mV
402	dVout()	Load Balancing	I(VREF) = 0...+1.6 mA	-10		+10	mV
403	Isc()hi	Short-Circuit Current hi	load current to ground	200	420	800	μ A
404	Isc()lo	Short-Circuit Current lo	load current to IC	2	4.5	10	mA

APPLICATION CIRCUITS

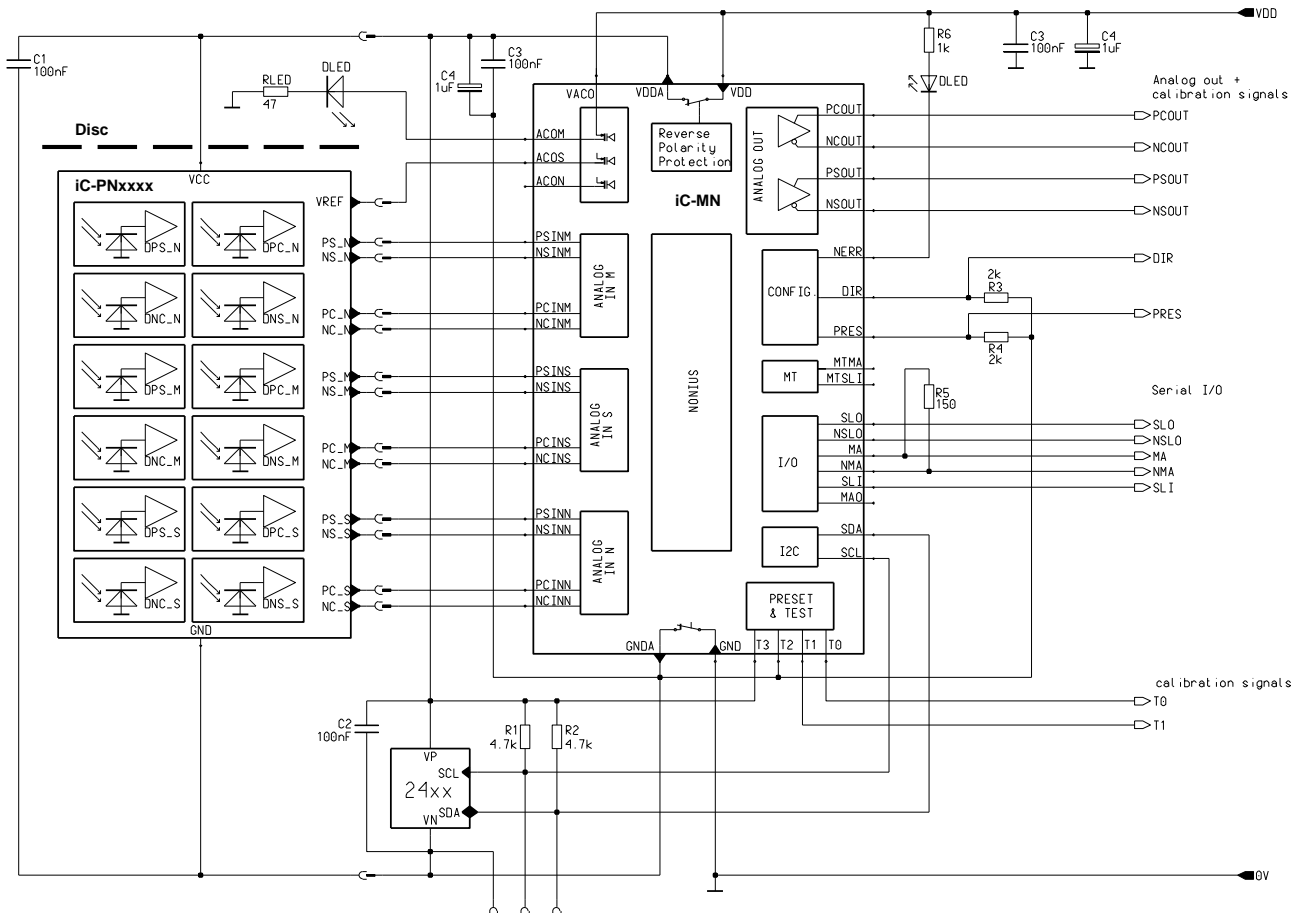


Figure 1: Application example of absolute encoder circuit.

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We understand suitable application of our published designs to be state-of-the-art technology which can no longer be classed as inventive under the stipulations of patent law. Our explicit application notes are to be treated only as mere examples of the many possible and extremely advantageous uses our products can be put to.

iC-PN3312

PHASED ARRAY NONIUS ENCODER 33-512

preliminary



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ORDERING INFORMATION

Type	Package	Options	Order Designation
iC-PN3312	-		iC-PN3312 chip
	32-pin optoQFN, 5 mm x 5 mm, thickness 0.9 mm		iC-PN3312 oQFN32-5x5
	15-pin optoBGA, 6.2 mm x 5.2 mm, thickness 1.7 mm		iC-PN3312 oBGA LSH2C
		Suitable code disc	
		511/512/496 PPR, OD \varnothing 33 mm, ID \varnothing 18.0 mm, optical radius 14.5 mm (glass 1 mm)	LSHC9S 33-512N

For technical support, information about prices and terms of delivery please contact:

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